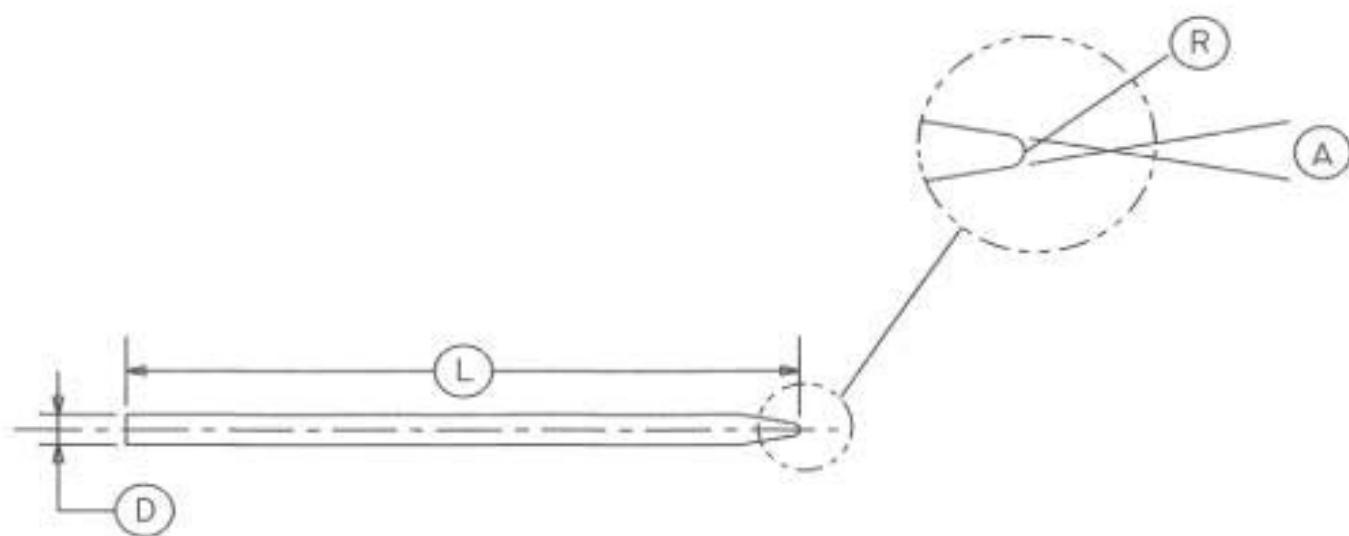


Ejector Needle

To push die out from 100% Sawthrough Wafer Tape.
Suitable for small die (Below 40x40 Mils)



L (LENGTH) MM	D (DIAMETER) MM	A (ANGLE) DEGREE	R (RADIUS) MM	MACHINE
15	0.635 / 0.7	10	0.022	KAIJO
15 / 16.5	0.7	10	0.022	FOTON
8 / 18	0.7	10 / 20	0.022	ESEC
14.3	0.7	10 / 15	0.022	AMI
19	0.7	10 / 20	0.022	ALPHASEM
16.5 / 18	0.7	10	0.022	ASM
11.5 / 12	0.7	10 / 15	0.022	SHINKAWA
20	0.7	10 / 15	0.022	NICHIDEN
29.6	0.84	20	0.022	WEST BOND
16.5	1	10	0.022	LEMAT

To order, Please specify L , D , A & R (MACHINE)